



SPECIFICATIONS

Rated Current:3.0AMP

Contact Resistance:20mΩ Max

Withstand Voltage:1000V AC/DC

Insulation Resistance:1000MΩ Min

Operation Temperature:-40°c to +105°c

Contact Material:Brass

Contact Plating:Au Over Ni

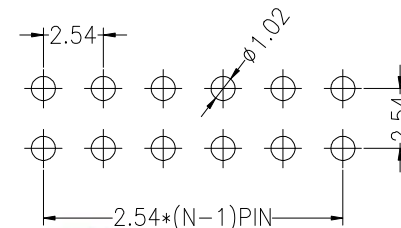
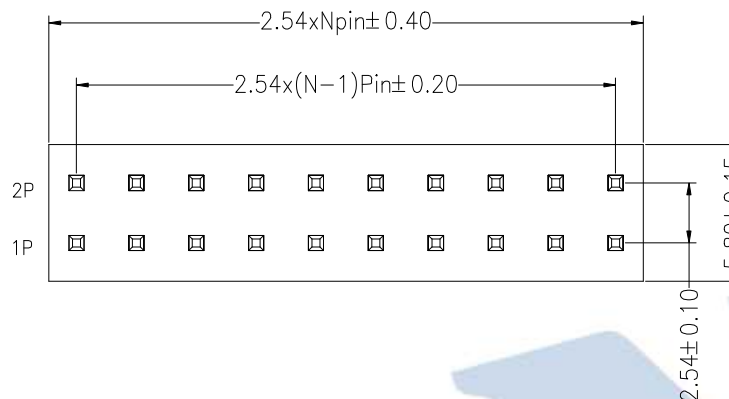
Insulator Material:Polyester(UL94V-0)

Resistance To Soldering Heat:

245° C±5° C, 10s(PBT insulator)

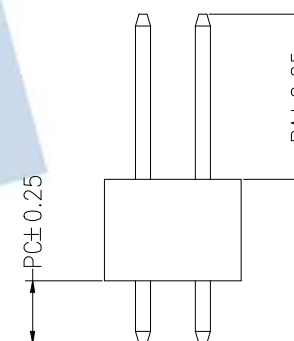
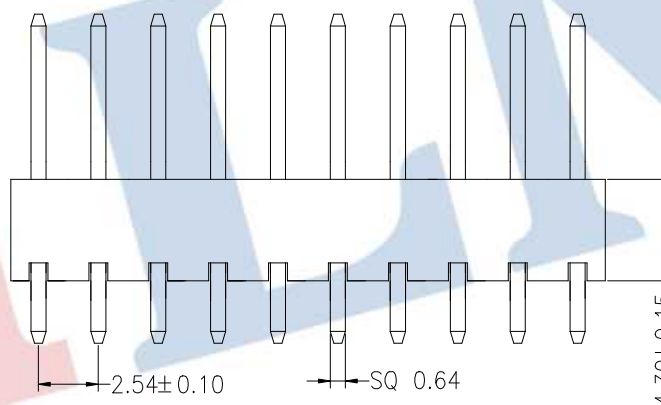
260° C±5° C, 10s(PA6T&PA9T&LCP insulator)

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE± 0.05)



Ordering Information

1243	1 2	XX	X	N	XX	S	XXX	X	0X
High.of Plastic 43=H4.3mm		No.of Pins Per Row 02~40P	Insulator Option A=BK-PBT C=BK-PA6T E=BK-PA9T F=BK-LCP	Material Option A=BK-PBT C=BK-PA6T E=BK-PA9T F=BK-LCP	Contact Plating G0:Gold Flash G1:1u" Gold G2:1.5u" Gold G3:2u" Gold G4:3u" Gold G5:5u" Gold G6:10u" Gold G7:15u" Gold G8:30u" Gold S0:Gold Flash/Tin SN:Tin	Pin Length	Packing 0=PE Bag A=Tray T=Tube P=Tube+Cap R=Reel+Cap M=Reel+Mylar		



Dimension antitheses list		
ITEM	PA	PC
Alternate	XXX	XXX

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				OPERATION		DRAW	RICH LIN	23.06.10	SCALE	FIT
				X.X	± 0.30				UNIT	mm
				X.XX	± 0.20	CHECK			SIZE	A4
				X.XXX	± 0.10		SHEET	1/1		
A0	2023.06.10	NEW DRAWING		Angle	± 3°	APPROVE			PROJ.	
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	DIM	TOL					